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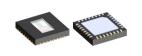
FEATURES

- Monolithic photodiode array with excellent signal matching
- Very compact size for small encoders
- Moderate track pitch for relaxed assembly tolerances
- Low noise signal amplifiers with high EMI tolerance
- Single-pin programming of 3 operating modes: analog, digital (2500 CPR), and x2 interpolated (5000 CPR)
- Analog signals for alignment and resolution enhancement
- ♦ Available with ungated or B-gated index signal (1 T or 0.5 T)
- Complementary outputs: A, B, Z and NA, NB, NZ
- Up to 20,000 RPM at 2500 CPR (10,000 RPM at 5000 CPR)
- U, V, W commutation signals, analog and digital
- All outputs +/- 4 mA push-pull, current-limited and short-circuit-proof
- ♦ LED power control with 40 mA high-side driver
- ♦ Single 3.5 V to 5.5 V operation, low power consumption
- ♦ Operating temperature range of -40 °C to +110 °C (+120 °C)
- ♦ Code disc available: PT5S 33-2500 (glass 1 mm) OD Ø33.2 mm, ID Ø13.0 mm, optical radius 14.5 mm, 2500 ppr and 4 ppr commutation (90°)

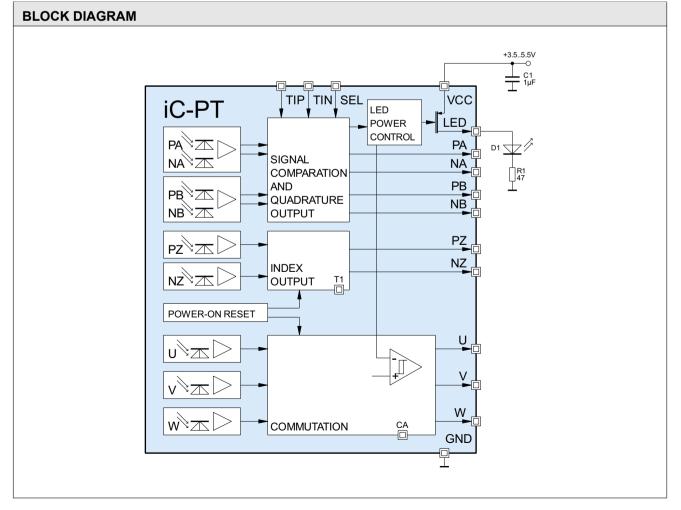


- Incremental encoder
- Brushless DC motor commutation
- Industrial drives

PACKAGES









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DESCRIPTION

iC-PT 3325 is an optical sensor IC with integrated photosensors whose signals are converted into voltages by low-noise transimpedance amplifiers. Precise voltage comparators with hysteresis are used to generate the digital signals, supplied to the output pins via differential +/- 4 mA push-pull drivers.

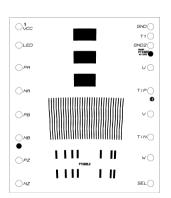
The built-in LED power control with its 40 mA driver stage permits a direct connection of the encoder LED. Regardless of aging or changes in temperature the received optical power is kept constant.

Selection input SEL chooses for three different operating modes: regular A/B operation, A/B operation with 2-fold interpolation, or analog operation. With analog operation the amplified signal voltages are available at the outputs for inspection and monitoring encoder assembly. Typical applications of iC-PT devices are incremental encoders for motor feedback and commutation. To this end, device version iC-PT 3325 provides differential A/B tracks and a differential index track, each consisting of multiple photo sensors. The layout of the signal amplifiers is such that there is an excellent paired channel matching, eliminating the needs for signal calibration.

Additionally, three more tracks are provided to generate motor commutation information for the U, V and W outputs, for instance with 90 degree phase shift to operate 4-phase brushless motors. The period count and phase shift can be varied by the code disc applied.

PACKAGING INFORMATION

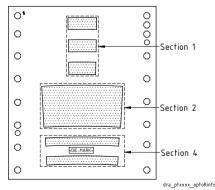
PAD LAYOUT Chip size 2.88 mm x 3.37 mm



PAD FUNCTIONS No. Name Function

See pin configuration.

SENSOR LAYOUT



AOI CRITERIA

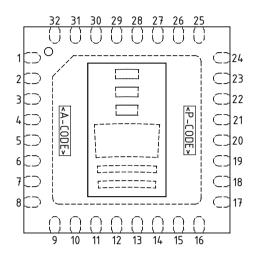
<die mark=""> iC PT3325.2</die>		<area class=""/> 1
	1, 4	A40
	2	A25

¹ Selection class for the optical inspection of detector areas. Refer to Optical Selection Criteria for further description.



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PIN CONFIGURATION oQFN32-5x5-1, oQFN32-5x5-2 (5 mm x 5 mm)



PIN FUNCTIONS

No. Name Function

- 1 VCC +3.5 V...+5.5 V Supply Voltage
- 2 LED LED Controller, High-Side Current Source Output
- 3 PA Push-Pull Output A+ / Analog Sin+ ¹
- 4 NA Push-Pull Output A- / Analog Sin-
- 5 PB Push-Pull Output B+ / Analog Cos+
- 6 NB Push-Pull Output B- / Analog Cos-
- 7 PZ Push-Pull Output Z+ / Analog Z+
- 8 NZ Push-Pull Output Z- / Analog Z-

9..16 n.c.²

- 17 SEL Op. Mode Selection Input: lo = digital
 - hi = x2 interpolated open = analog (alignment aid)
- Open analog (alignment alu)
- 18 W Push-Pull Output W / Analog W
- 19 TIN Negative Test Current Input ³
 20 V Push-Pull Output V / Analog V
- 21 TIP Positive Test Current Input ³
- 22 U Push-Pull Output U / Analog U
- 23 n.c.

24 GND Ground

- 25..32 n.c.
 - BP Backside Paddle ⁴

IC top marking: <P-CODE> = product code, <A-CODE> = assembly code (subject to changes);

¹ Capacitive pin loads must be avoided when using the analog output signals.

² Pin numbers marked n.c. are not connected.

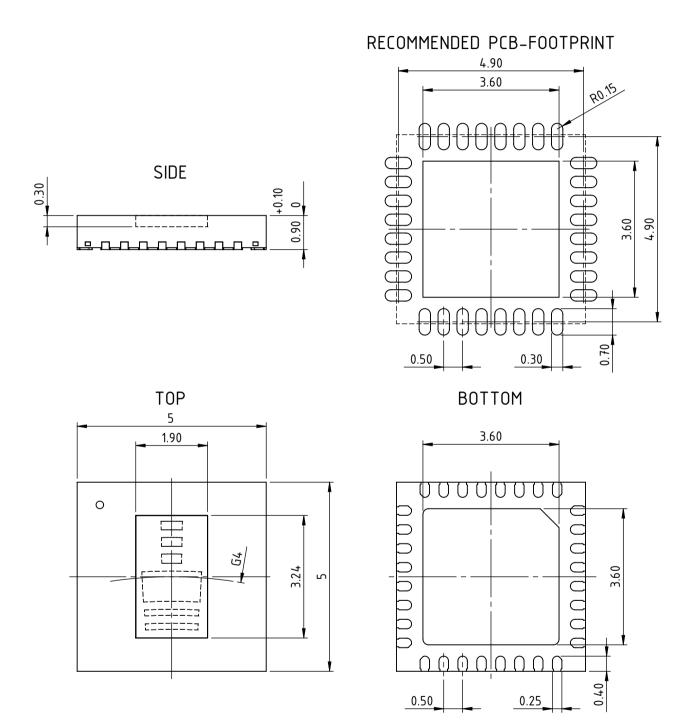
³ The test pins TIP and TIN may remain unconnected.

⁴ Connecting the backside paddle is recommended by a single link to GND. A current flow across the paddle is not permissible.



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PACKAGE DIMENSIONS



All dimensions given in mm. General Tolerances of form and position according to JEDEC MO-220. Positional tolerance of sensor pattern: ±70µm / ±1° (with respect to center of backside pad). G4: radius of chip center (refer to the relevant encoder disc and code description). Maximum molding excess +20µm / -75µm versus surface of glass. Small pits in the mold surface, which may occasionally appear due to the manufacturing process, are cosmetic in nature and do not affect reliability.

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ABSOLUTE MAXIMUM RATINGS

These ratings do not imply operating conditions; functional operation is not guaranteed. Beyond these ratings device damage may occur.

Item	Symbol	Parameter	Conditions			Unit
No.				Min.	Max.	
G001	VCC	Voltage at VCC		-0.3	6	V
G002	I(VCC)	Current in VCC		-20	20	mA
G003	V()	Voltage at Output Pins PA, NA, PB, NB, PZ, NZ, U, V, W		-0.3	VCC + 0.3	V
G004	I()	Current in Output Pins PA, NA, PB, NB, PZ, NZ, U, V, W		-20	20	mA
G005	V()	Voltage at LED		-0.3	VCC + 0.3	V
G006	I()	Current in LED		-120	20	mA
G007	V()	Voltage at TIP, TIN, SEL		-0.3	VCC + 0.3	V
G008	I()	Current in TIP, TIN, SEL		-20	20	mA
G009	Vd()	ESD Susceptibility, all pins	HBM, 100 pF discharged through $1.5 \text{ k}\Omega$		2	kV
G010	Tj	Junction Temperature		-40	150	°C
G011	Ts	Chip Storage Temperature Range		-40	150	°C

THERMAL DATA

Item Symbol		Parameter	Conditions				
No.				Min.	Тур.	Max.	
T01	Та	Operating Ambient Temperature Range		-40		110	°C
T02	Ts	Permissible Storage Temperature Range		-40		120	°C
Т03	Tpk		tpk < 20 s, convection reflow tpk < 20 s, vapor phase soldering MSL 5A (max. floor life 24 h at 30 °C and 60 % RH); Refer to Handling and Soldering Conditions for details.			245 230	℃ ℃



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ELECTRICAL CHARACTERISTICS

ltem	Symbol	Parameter	Conditions				Unit
No.	Devilee			Min.	Тур.	Max.	
	Device	Demois site to Ormania Matterna		0.5	1		
001	VCC	Permissible Supply Voltage		3.5		5.5	V
002	I(VCC)	Supply Current in VCC	no load, photocurrents within op. range		3	10	mA
003	Vc()lo	Clamp-Voltage lo at all pins	I() = -4 mA, versus GND	-1.2		-0.3	V
004	Vc()hi	Clamp-Voltage hi at all pins	I() = 4 mA			11	V
005	Vc()hi	Clamp-Voltage hi at LED, PA, NA, PB, NB, PZ, NZ, U, V, W	· · ·	0.3		1.2	V
006	Vc()hi	Clamp-Voltage hi at SEL, TIP, TIN	I() = 4 mA, versus VCC	0.7		2.2	V
Photo	sensors	·					
101	λ ar	Spectral Application Range	$Se(\lambda ar) = 0.25 \times S(\lambda)max$	400		950	nm
102	λpk	Peak Sensitivity Wavelength			680		nm
103	Aph()	Radiant Sensitive Area	PA, PB, NA, NB (sum of segments) U, V, W (per segment) PZ, NZ (sum of segments)		0.072 0.1 0.038		mm ² mm ² mm ²
104	S(λr)	Spectral Sensitivity	λ_{LED} = 740 nm λ_{LED} = 850 nm		0.5 0.3		A/W A/W
106	E()mxpk	Permissible Irradiance	λ _{LED} = λpk, Vout() < Vout()mx; PA, PB, NA, NB		2.3		mW/ cm ²
			U, V, W		1.1		mW/ cm ²
			PZ, NZ		3.2		mW/ cm ²
Photo	current Am	plifiers					
201	lph()	Permissible Photocurrent Operating Range		0		550	nA
202	η()r	Photo Sensitivity (light-to-voltage conversion ratio)	for PA, PB, NA, NB for PZ, NZ, U, V, W	0.1 0.2	0.3 0.4	0.5 0.6	V/µW V/µW
203	Z()	Equivalent Transimpedance Gain	Z = Vout() / Iph(), Tj = 27 °C; for PA, PB, NA, NB for PZ, NZ, U, V, W	0.56 0.66	0.75 1.0	1 1.36	ΜΩ ΜΩ
204	TCz	Temperature Coefficient of Tran- simpedance Gain			-0.12		%/°C
205	ΔZ()pn	Transimpedance Gain Matching	SEL open, P vs. N path per diff. channel	-0.2		0.2	%
206	∆Vout()	Dark Signal Matching of A, B	SEL open, output vs. output	-8		8	mV
207	∆Vout()	Dark Signal Matching of U, V, W	SEL open, output vs. output	-12		12	mV
208	∠Vout()	Dark Signal Matching of A, B, Z, U, V, W	SEL open, any output vs. any output	-24		24	mV
209	∆Vout()pn	Dark Signal Matching	SEL open, P vs. N path per diff. channel	-2.5		2.5	mV
211	fc()hi	Cut-off Frequency (-3 dB)		400	500		kHz
Analo	og Outputs P	A, NA, PB, NB, PZ, NZ, U, V, W	L		1	1	1
301	Vout()mx		illumination to E()mxpk	1.04	1.27	1.8	V
302	Vout()d	Dark Signal Level	load 100 kΩ vs. +2 V	560	770	985	mV
303	0	Maximum Signal Level	Vout()acmx = Vout()mx - Vout()d	0.3	0.5	0.75	V
304	lsc()hi	Short-Circuit Current hi	SEL open, load current to ground	100	1800	3000	μA
305	lsc()lo	Short-Circuit Current lo	SEL open, load current to IC	20	40	200	μA
306	Ri()	Internal Output Resistance	f= 1 kHz	250	750	2250	Ω
	arators		1			1	
401	Vt()hi	Upper Comparator Threshold	lph()p x Z()p > lph()n x Z()n, resp. lph()p x Z()p > internal VREF	5	12	25	mV
402	Vt()lo	Lower Comparator Threshold	lph()p x Z()p < lph()n x Z()n, resp. lph()p x Z()p < internal VREF	-25	-12	-5	mV
403	Vt()hys	Comparator Hysteresis	Vt()hys = Vt()hi - Vt()lo	10	24	50	mV



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ELECTRICAL CHARACTERISTICS

ltem No.	Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
-	Power Cont	rol			.,,,,,	maxi	
501	lop()	Permissible LED Output Current		-40		0	mA
502	Vs()hi	Saturation Voltage hi	Vs()hi = VCC - V(LED); I() = -40 mA	0.25	0.5	1	V
503	lsc()hi	Short-Circuit Current hi	V() = 0 V	-150		-50	mA
Digita		, NA, PB, NB, PZ, NZ, U, V, W	, v	I	1		
601	fout	Maximum Output Frequency		800			kHz
602	Vs()lo	Saturation Voltage lo	VCC = 4.55.5 V, I() = 4mA, Tj = 70 °C			0.4	V
603	Vs()lo	Saturation Voltage lo	VCC = 4.55.5 V, I() = 4mA, Tj = 85 °C			0.5	V
604	Vs()lo	Saturation Voltage Io	VCC = 3.54.5 V, I() = 4mA			0.6	V
605	lsc()lo	Short-Circuit Current lo	V() = VCC	7		70	mA
606	Vs()hi	Saturation Voltage hi	Vs()hi = VCC - V(), I() = -4 mA; VCC = 4.55.5 V VCC = 3.54.5 V			0.4 0.6	V V
607	lsc()hi	Short-Circuit Current hi	V() = 0 V	-70		-7	mA
Select	tion Input S	EL	1				
701	Vt1()hi	Upper Threshold Voltage hi	for A/B mode with x2 interpolation	78	80	82	%VCC
702	Vt1()lo	Upper Threshold Voltage lo	for A/B mode with x2 interpolation	68	70	72	%VCC
703	Vt1()hys	Upper Threshold Hysteresis	Vt1()hys = Vt1()hi - Vt1()lo	8	10	12	%VCC
704	Vt2()hi	Lower Threshold Voltage hi	for A/B mode	28	30	32	%VCC
705	Vt2()lo	Lower Threshold Voltage lo	for A/B mode	18	20	22	%VCC
706	Vt2()hys	Lower Threshold Hysteresis	Vt2()hys = Vt2()hi - Vt2()lo	8	10	12	%VCC
707	V0()	Pin-Open Voltage	for analog mode	45	50	55	%VCC
708	Rpd()	Pull-Down Resistor	SEL to GND, V(SEL) = VCC	70	100	140	kΩ
709	Rpu()	Pull-Up Resistor	VCC to SEL, V(SEL) = 0 V	70	100	140	kΩ
710	Vpd()	Pull-Down Voltage vs. VCC/2	Vpd() = V() - VCC/2; I() = 05 µA			0.5	V
711	Vpu()	Pull-Up Voltage vs. VCC/2	Vpu() = V() - VCC/2; I() = -50 µA	-0.5			V
Test C	Circuit Inpu	ts TIP, TIN					
801	I()test	Permissible Test Current Range	test mode active	10		600	μA
802	V()test	Test Pin Voltage	test mode active, I() = 200 µA	1.25	1.5	1.75	V
803	lpd()	Test Pin Pull-Down Current	test mode not active, V() = 0.4 V	60	100	160	μA
804	lpd()	Test Pin Pull-Down Current	V()=VCC	0.7	2	3	mA
805	lt()on	Test Mode Activation Threshold		80	130	190	μA
806	CR()	Test Mode Current Ratio I()/Iph()	test mode active, I() = 200 μA	1500	3000	5000	
Powe	r-On-Reset	Circuit					
901	VCCon	Turn-on Threshold VCC (power-on release)	increasing voltage at VCC		2.6	3.45	V
902	VCCoff	Turn-off Threshold VCC (power-down reset)	decreasing voltage at VCC	1.4	2.4		V
903	VCChys	Threshold Hysteresis	VCChys = VCCon - VCCoff	50	170	300	mV



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DIGITAL OUTPUT SIGNALS

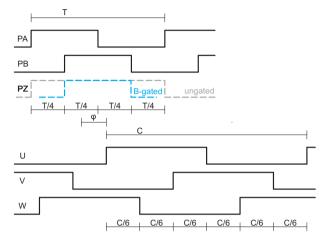


Figure 1: Encoder quadrature and motor commutation signals

iC-PT3325's phased array design determines the optical radius (14.5 mm) and the cycles per revolution for the A and B encoder quadrature signals (2500 CPR native, respectively 5000 CPR interpolated).

The pulse count, period length and phase shift for the U, V, W commutation signals is determined by the code disc.

Sampling is supported by code disc PT5S 33-2500 providing 4 CPR each for U/V/W, with a period length of 90 degrees (C).

A phase shift of 0 degrees (φ) between U and Z edges must be considered during alignment. For detailed specifications, refer to the relevant code disc datasheet, available separately.

ANALOG OUTPUT SIGNALS

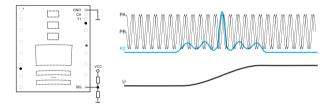


Figure 2: Analog signal output (pin SEL open).

When the operating mode selection input SEL is left open, all digital outputs are disabled and analog output signals are available for test and alignment.

If analog signals are desired permanently, noise immunity can be improved by wiring pin SEL to an external VCC/2 reference.



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INDEX GATING oQFN32-5x5-1

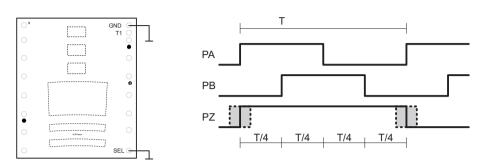


Figure 3: Ungated index signal at x1 interpolation (SEL = low).

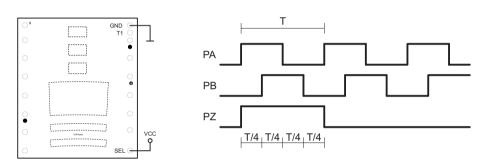
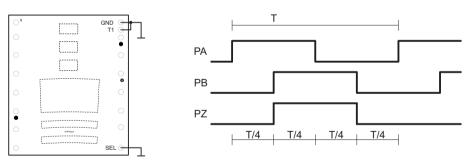
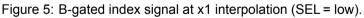


Figure 4: T-gated index signal at x2 interpolation (SEL = high).

INDEX GATING oQFN32-5x5-2





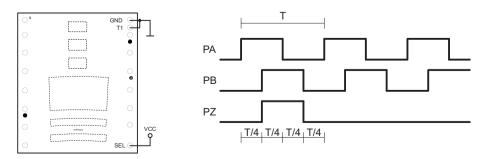


Figure 6: B-gated index signal at x2 interpolation (SEL = high).



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APPLICATION NOTES

Application notes for iC-PTxx series ICs are available separately.

DESIGN REVIEW: Notes on Chip Functions

iC-PT3325	iC-PT3325						
No.	Function, Parameter/Code	Description and Application Hints					
1	Index gating 1/4 T	Index length preset to 1/4 T (AB-gated).					

Table 4: Chip release iC-PT3325

iC-PT3325_	iC-PT3325_2							
No.	Function, Parameter/Code	Description and Application Hints						
1	Index gating	Package oQFN32-5x5-1: Index length preset to 1 T (ungated/T-gated). Pin 23 is not connected.						
		Package oQFN32-5x5-2: Index length preset to 0.5 T (B-gated). Pin 23 is not connected.						

Table 5: Chip release iC-PT3325_2

REVISION H	ISTORY	

Rel.	Rel. Date ¹	Chapter	Modification	Page
C1	2021-08-02	PACKAGING INFORMATION	AOI criteria added with hyperlink to customer information	2
		PACKAGE DIMENSIONS	Update of package drawing and footnote	4
		THERMAL DATA	Item T03: hyperlink to customer information	5
		ELECTRICAL CHARACTERISTICS	Item 302: min. limit adapted	6

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ORDERING INFORMATION

Туре	Package	Options	Order Designation
iC-PT3325	32-pin optoQFN, 5 mm x 5 mm, thickness 0.9 mm RoHS compliant	Index length preset to 1 T (ungated/T-gated)	iC-PT3325 oQFN32-5x5-1
		Index length preset to 0.5 T (B-gated)	iC-PT3325 oQFN32-5x5-2
Code Disc		2500 PPR +4 PPR, OD/ID ∅33.2/13.0 mm, glass 1 mm	PT5S 33-2500

Please send your purchase orders to our order handling team:

Fax: +49 (0) 61 35 - 92 92 - 692 E-Mail: dispo@ichaus.com

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